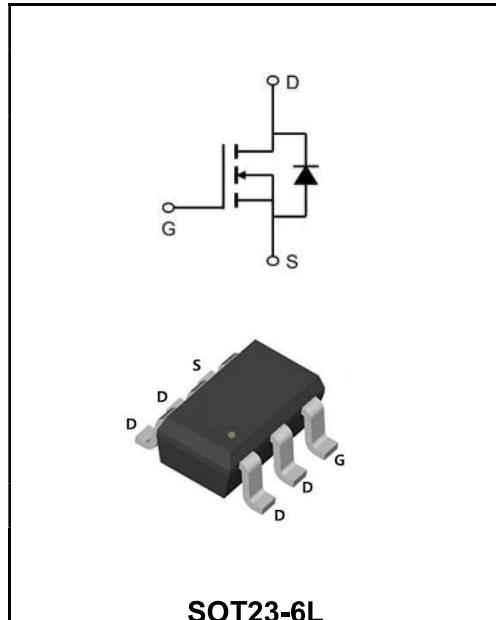


60V N-CHANNEL ENHANCEMENT MODE MOSFET
MAIN CHARACTERISTICS

I_D	6A
V_{DSS}	60V
$R_{DS(on)-typ}(@V_{GS}=10V)$	< 40mΩ (Type: 36 mΩ)


SOT23-6L
Marking Code

YFW6N06LI	6N06
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Maximum Ratings at $T_c=25^\circ\text{C}$ unless otherwise specified

Characteristics	Symbols	Value	Units
Drain-Source Voltage	V_{DS}	60	V
Gate - Source Voltage	V_{GS}	± 20	V
Continuous Drain Current, $V_{GS} @ 10V^1$ @ $T_c=25^\circ\text{C}$	I_D	6	A
Continuous Drain Current, $V_{GS} @ 10V^1$ @ $T_c=100^\circ\text{C}$	I_D	3.5	A
Pulsed Drain Current	I_{DM}	18	A
Single Pulse Avalanche Energy	E_{AS}	22	mJ
Power Dissipation @ $T_c=25^\circ\text{C}$	P_D	2	W
Operating and Storage Temperature Range	T_J, T_{STG}	-55 to +175	°C
Thermal Resistance Junction-Ambient ¹	$R_{\theta JA}$	125	°C/W
Thermal Resistance Junction-Case ¹	$R_{\theta JC}$	4	°C/W

Maximum Ratings at Tc=25°C unless otherwise specified

Characteristics	Test Condition	Symbols	Min	Typ	Max	Units
Drain-Source Breakdown Voltage	V _{GS} =0V, I _D =250uA	BV _{DSS}	60	65	-	V
BVDSS Temperature Coefficient	Reference to 25°C , I _D =1mA	ΔBV _{DSS/ΔTJ}	-	0.044	-	V/°C
Static Drain-Source On-Resistance ²	V _{GS} =10V, I _D =15A	R _{DS(ON)}	-	36	40	mΩ
	V _{GS} =4.5V, I _D =7A		-	40	48	
Gate -Threshold Voltage	V _{DS} =V _{GS} , I _D =250uA	V _{GS(th)}	1.2	1.6	2.5	V
V _{GS(th)} Temperature Coefficient		ΔV _{GS(th)}	-	-4.8	-	mV/°C
Drain -Source Leakage Current	V _{DS} =48V , V _{GS} =0V , T _J =25°C	I _{DSS}	-	-	1	μA
	V _{DS} =48V , V _{GS} =0V , T _J =55°C		-	-	5	
Gate-Source Leakage Current	V _{GS} =±20V, V _{DS} =0V	I _{GSS}	-	-	±100	nA
Forward Transconductance	V _{DS} =5V, I _D =15A	g _{FS}	-	25.3	-	S
Gate Resistance	V _{DS} =0V , V _{GS} =0V , f=1MHz	R _G	-	2.5	-	Ω
Total Gate Charge(10V)	V _{DS} =48V V _{GS} =10V I _D =15A	Q _g	-	19	-	nC
Gate-Source Charge		Q _{gs}	-	2.5	-	
Gate-Drain Charge		Q _{gd}	-	5	-	
Turn-on delay time	V _{DD} =30V V _{GS} =10V R _G =3.3Ω I _D =15A	t _{d(on)}	-	2.8	-	ns
Rise Time		T _r	-	16.6	-	
Turn-Off Delay Time		t _{d(OFF)}	-	21.2	-	
Fall Time		t _f	-	5.6	-	
Input Capacitance	V _{DS} =15V V _{GS} =0V f=1.0MHz	C _{iss}	-	1027	-	pF
Output Capacitance		C _{oss}	-	65	-	
Reverse Transfer Capacitance		C _{rss}	-	46	-	
Continuous Source Current ^{1,6}	V _G =V _D =0V , Force Current	I _s	-	-	20	A
Pulsed Source Current ^{2,6}		I _{SM}	-	-	40	A
Diode Forward Voltage ²	V _{GS} =0V , I _s =1A , T _J =25°C	V _{SD}	-	-	1.2	V
Reverse Recovery Time	I _F =15A , dI/dt=100A/μs , T _J =25°C	t _{rr}	-	12.2	-	ns
Reverse Recovery Charge		Q _{rr}	-	7.3	-	nC

Note :

- 1、The data tested by surface mounted on a 1 inch² FR-4 board with 2OZ copper.
- 2、The data tested by pulsed , pulse width .The EAS data shows Max. rating .
- 3、The test cond \leq 300us duty cycle \leq 2%, duty cycle ition is T_J =25°C, VDD =48V, VG =10V, RG =25Ω, L=0.1mH, IAS =13A
- 4、The power dissipation is limited by 175°C junction temperature
- 5、The data is theoretically the same as ID and IDM , in real applications , should be limited by total power dissipation.

Ratings and Characteristic Curves

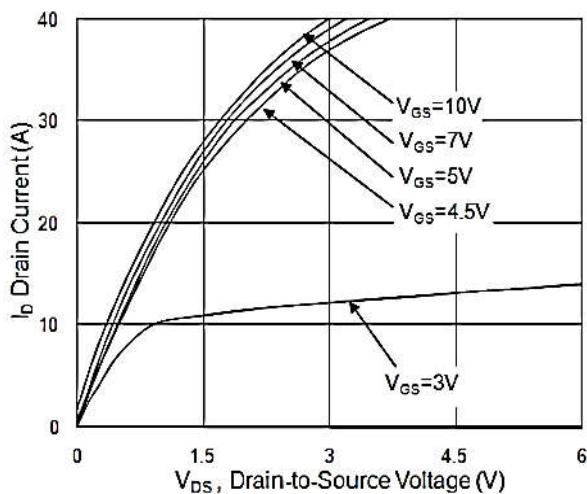


Fig.1 Typical Output Characteristics

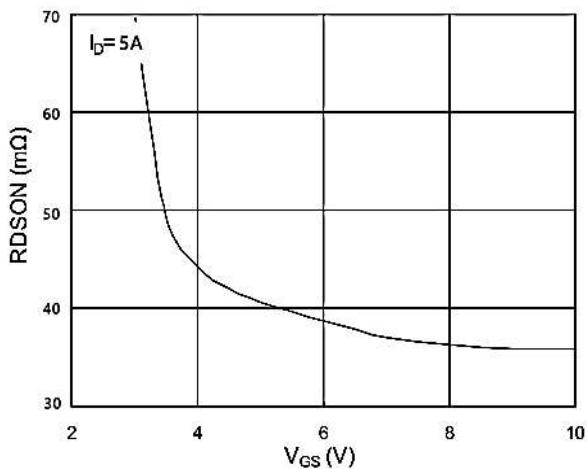


Fig.2 On-Resistance vs. Gate-Source

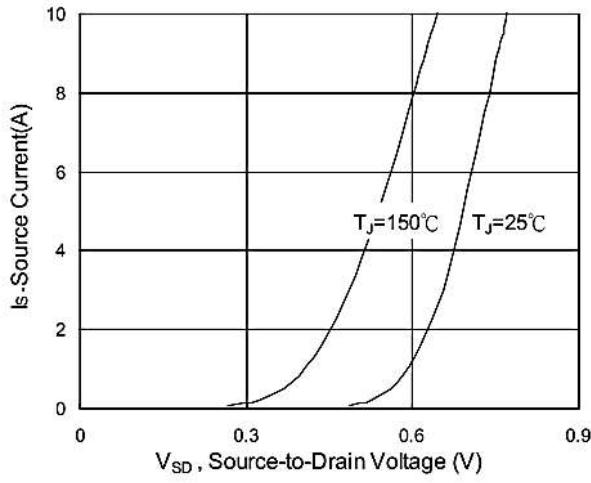


Fig.3 Forward Characteristics Of Reverse

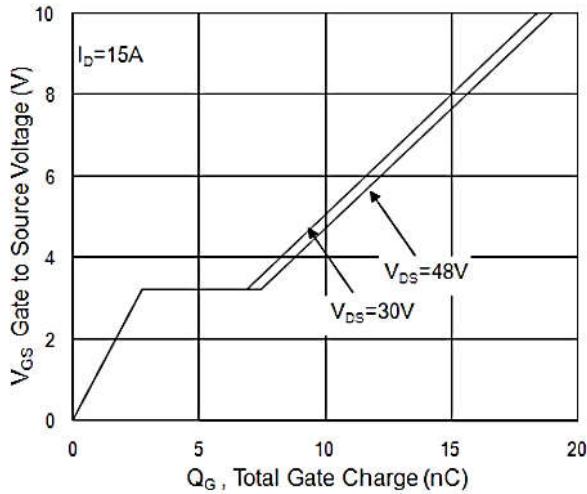


Fig.4 Gate-Charge Characteristics

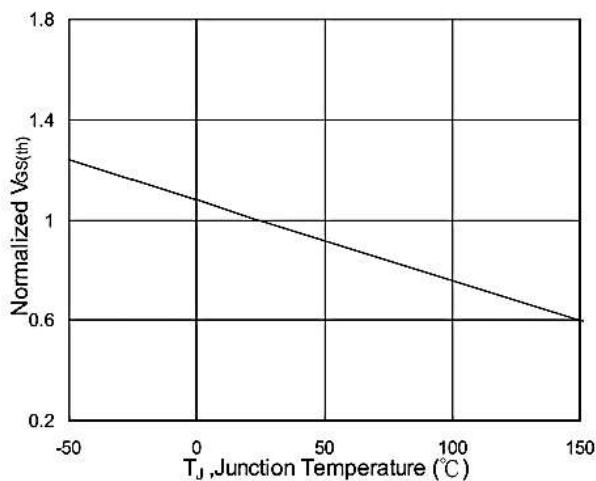


Fig.5 Normalized V_{GS(th)} vs. T_J

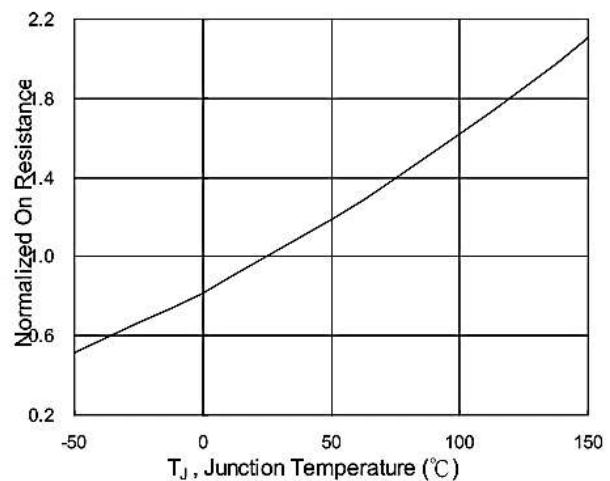
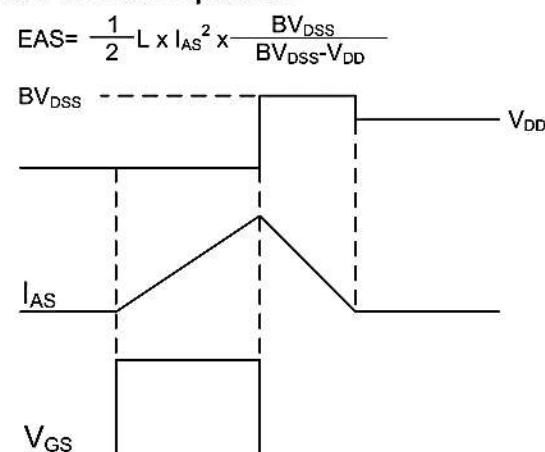
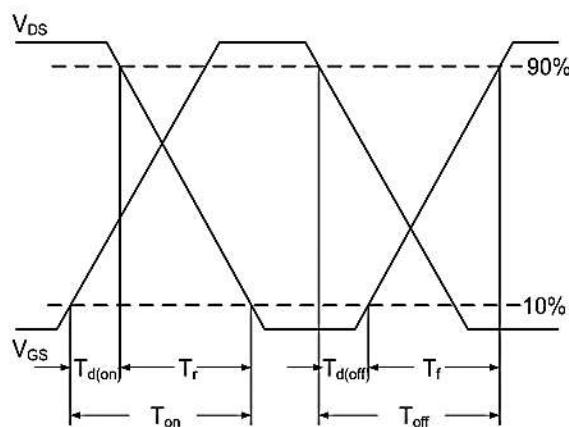
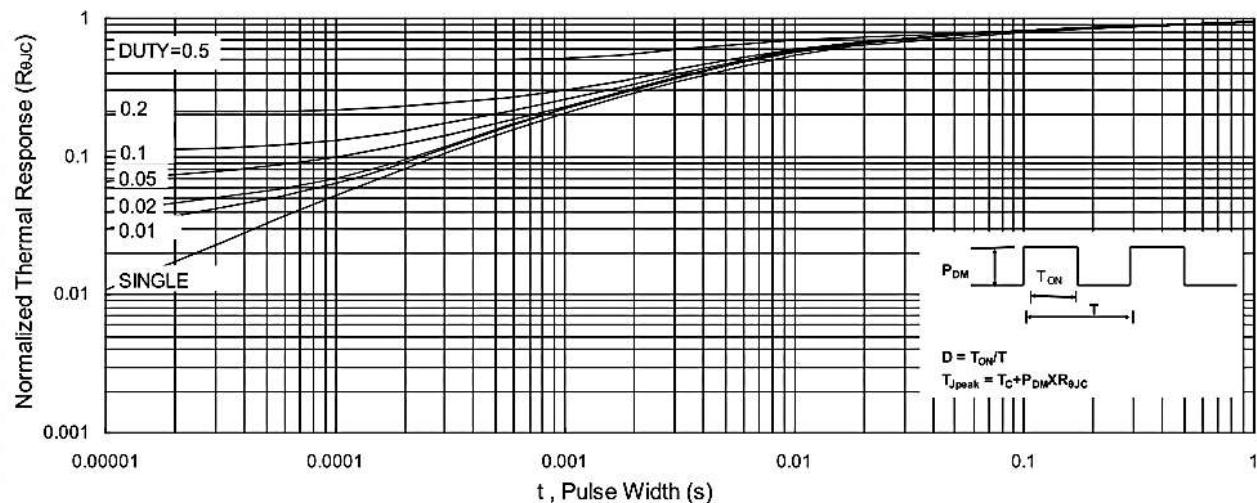
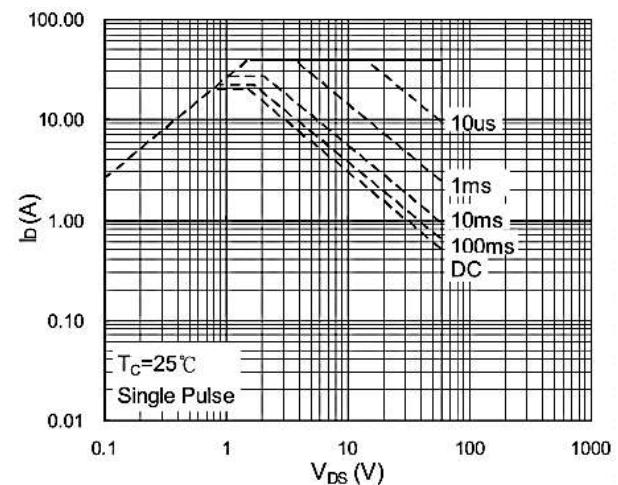
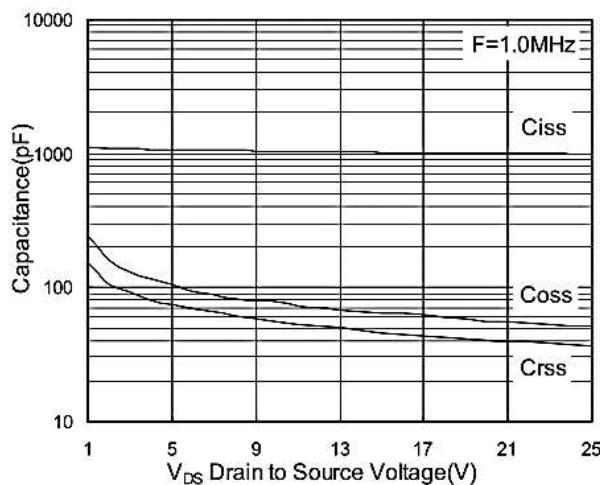


Fig.6 Normalized R_{DSON} vs. T_J

Ratings and Characteristic Curves



Ordering information

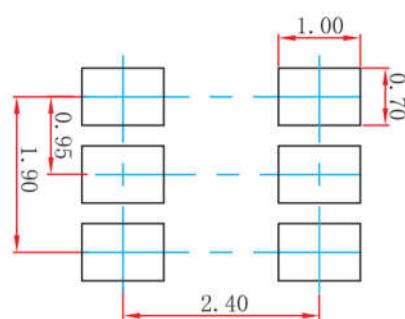
Package	Packing Description	Packing Quantity
SOT23-6L	Tape/Reel,7"reel	3000PCS/Reel 120000PCS/Carton

Package Dimensions

SOT23-6L

Dim.	Millimeter(mm)		mil	
	Min.	Max.	Min.	Max.
A	1.05	1.25	41	49
A1	0	0.10	0	3.9
A2	1.05	1.15	41	45
b	0.30	0.50	11.8	19.7
c	0.10	0.20	3.9	7.9
D	2.82	3.02	111	119
E1	1.50	1.70	45	67
E	2.65	2.95	104	116
e	0.950(BSC)		37(BSC)	
e1	1.80	2.00	71	79
L	0.30	0.60	11.8	23.6
θ	0°	8°	0°	8°

The recommended mounting pad size



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